

SAMXON BRAND ALUMINUM ELECTROLYTIC CAPACITORS PRODUCT SPECIFICATION 規格書

| CUSTOMER : | • |
|-------------------|---|
| | |

(客戶): 志盛翔

DATE: (日期):2016-01-18

| CATEGORY (品名) | : ALUMINUM ELECTROLYTIC CAPACITORS |
|------------------|------------------------------------|
| DESCRIPTION (型号) | : KM 250V47μF(φ12.5x20) |
| VERSION (版本) | : 01 |
| Customer P/N | : |
| SUPPLIER | : |
| | |

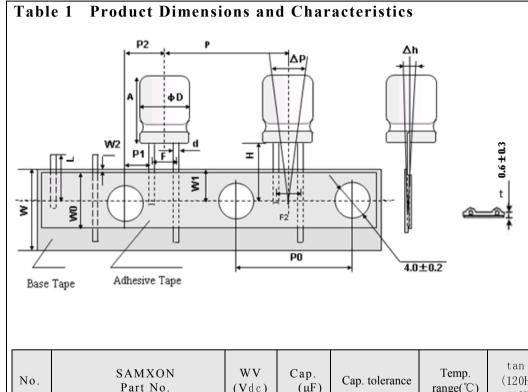
| SUPPLI | ER | CUSTOMER | | | | | |
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| PREPARED (拟定) | | | SIGNATURE (签名) | | | | |
| 郭梦玉 | 王国华 | | | | | | |

ELECTROLYTIC CAPACITOR SPECIFICATION KM SERIES

| KWI SERIES | ALTERNATION HISTORY RECORDS | | | |
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| | after Approver | | | |
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| MAN YUE ELECTRONICS | ELECTROLYTIC CAPACITOR | SAMXON |
|---------------------|----------------------------|--------|
| COMPANY LIMITED | SPECIFICATION KM SERIES | |
| | | · |



| | | | Unit: | mm | | | | |
|---------------------|--------------------------|-----------------------|------------------|---------------------|------------------------|--|--|--|
| Т | aping Coo | le | ТС-Ф12.5(F=5.0) | | | | | |
| D±0.5 | A+2.0 | d±0.05 | P±1.0 | P ₀ ±0.2 | $P_1 \pm 0.5$ | | | |
| 12.5 | 20 | 0.6 | 12.7 | 12.7 | 5.0 | | | |
| P ₂ ±1.0 | $F_{-0.5}^{+0.8}$ | $F_{2}^{+0.8}_{-0.5}$ | W $^{+1}_{-0.5}$ | W_0 | W1±0.5 | | | |
| 7.5 | 5.0 | 5.0 | 18 | 12min | 9 | | | |
| W_2 | W_2 $H^{+0.75}_{-0.5}$ | | L | riangle h | $\triangle \mathbf{P}$ | | | |
| 3max | 18.5 | | 11max | 2max | 1.3 max | | | |

| No. | SAMXON Part No. | WV (Vdc) | Cap. (µF) | Cap. tolerance | Temp. range(℃) | tanδ (120Hz, 20℃) | Leakage Current (µA,2min) | Max Ripple Current at 105°C 100KHz (mA rms) | Impedance at $\geq 27 \ C$ 100kHz (Ω) | Load lifetim e (Hrs) | Dime: (n D×L | nsion nm) F | фd | Sleev e |
|-----|--------------------|-------------|--------------|----------------|-------------------|-------------------------|---------------------------------|---|---|-------------------------------|--------------------|-------------------|-----|------------|
| 1 | EKM476M2EI20TC**Z1 | 250 | 47 | -20%~+20% | -25~105 | 0.20 | 393 | 375 | 0.6 | 2000 | 12.5X20 | 5.0 | 0.6 | PET |

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ELECTROLYTIC CAPACITOR SPECIFICATION KM SERIES

SAMXON

1. Application

This specification applies to polar Aluminum electrolytic capacitor (foil type) used in electronic equipment. Designed capacitor's quality meets IEC60384.

| 2. | Par | t Numb | oer S | System | | | | | | | | |
|----|-------------------|----------|-------|--------------|------------------|----------------|------------|--|-------------|------|--|---|
| [| 1 2 | 3 4 | 56 | 3 7 | · | 89 | ľ | 10 11 1: | 2 131 | 14 | 1516 | 17 |
| E | EG | S 1 | 0 5 | 5 N | 1 | 1 H | | D11 | — Т (| С | SA | Ρ |
| | SERIES | CAP | | CE TO | L. | VOLTAGE | | CASE SIZE | E TYP | E, | SAMXON PRODUCT LINE N | SLEEVE |
| | | | | I | | | | | | | | |
| | Series | Cap(MFD) | Code | Tolerance (% |) Code | Voltage (W.V.) | Code | Case Size | Feature (| Code | SAMXON Product L | ine |
| | ESM EKF | 0.1 | 104 | ±5 | J | 2 | 0D 0E | Diameter(| Radial bulk | RR | For internal use only | |
| | ESS EKS | 0.00 | | | | 4 | 0E 0G | 3.5 1 4 C 5 D | Ammo Tap | ina | (The product lines we have H,A,B,C,D, | |
| IE | EGS EKM | 0.22 | 224 | ±10 | ĸ | 6.3 | OJ | 6.3 E | | | E,M or 0,1,2,3,4,5,9 | |
| IF | EKG EOM | 0.33 | 334 | | | 8 | 0K 1A | 8 F 10 G | 2.0mm Pitch | тт | | |
| IF | EZM EZS | 0.47 | 474 | ±15 | - | 12.5 | 1B | 12.5 I 13 J | 2.5mm Pitch | τυ | | |
| IF | EGF ESF | | | ±20 | м | 16 20 | 1C 1D | 13.5 V 14 4 | 3.5mm Pitch | - | | |
| IF | EGT EGK | 1 | 105 | #20 | | 25 | 1E | 14.5 A 16 K | 3.5mm Pitch | τv | Sleeve Material | Code |
| IF | EGE EGD | 2.2 | 225 | ±30 | N | 30 32 | 1I 13 | 16.5 7 18 L | 5.0mm Pitch | тс | PET | P |
| IF | EGC ERS | 3.3 | 335 | -40 | 1 | 32 | 13 1V | 18.5 8 20 M | Lead Cut & | Form | | |
| IF | ERF | | | 0 | w | 40 | 1G | 20 M 22 N 25 O 30 P 34 W 40 R 42 4 45 6 51 S 63.5 T | СВ-Туре | СВ | PVC | If the sleeve material is PVC, there will be blank in seventeenth digit |
| IF | ERR | 4.7 | 475 | -20 0 | A | 42 50 | 1M 1H | 30 P 34 W | СБ-туре | СВ | | slee |
| IF | ERE | 10 | 106 | | + | 57 | 1L | 35 Q 40 R | CE-Type | CE | | Ne II |
| IF | ERH EBD | 22 | 226 | -20 +10 | c | 63 71 | 1J 1S | 42 4 45 6 | HE-Type | HE | | nater |
| IF | ERA ERB | | 220 | -20 +40 | x | 75 | 1 T | 51 S 63.5 T 76 U | KD-Type | КD | | al is |
| IF | ERC EFA | 33 | 336 | | | 80 | 1K 1R | 80 8 | КО-туре | KD | | 8 |
| IF | ENP | 47 | 476 | -20 +50 | s | 90 | 19 | 90 X 100 Z | FD-Type | FD | | the |
| IF | ERW | 100 | 107 | -10 | в | 100 | 2A | Len.(mm) Code 4.5 45 5 05 | EH-Type | EH | | 19 Wi |
| IF | ELP | 100 | 107 | 0 | | 120 125 | 20 2B | 5 05 5.4 54 | | | | 6 |
| IF | EQP | 220 | 227 | -10 +20 | v | 150 | 2Z | 5.4 54 7 07 7.7 77 | PCB Term | na | | blank |
| IF | ETP | 330 | 337 | -10 | Q | 160 180 | 2C 2P | 10.2 T2 11 11 11.5 1A | | sw | | S S |
| IF | EUP | | | +30 | <u> </u> | 200 | 2D | 11.5 1A 12 12 12.5 1B 13 13 | Snap-in | sx | | even |
| IF | EEP EFP | 470 | 477 | -10 +50 | T | 215 220 | 22 2N | 12 12 12.5 1B 13 13 | | 07 | | leent |
| IF | ESP | 2200 | 228 | -5 +10 | E | 230 | 23 | 13.5 1C 20 20 25 25 29.5 2J | | sz | | hdig |
| F | EGP | 22000 | 229 | | + | 250 275 | 2E 2T | 25 25 29.5 2J | Lug | SG | | F |
| F | EWU | 22000 | 200 | -5 +15 | F | 300 | 21 | 30 30 31.5 3A 35 35 | | 05 | L | |
| IF | EWX | 33000 | 339 | -5 +20 | G | 310 | 2R | 35.5 3E | | 06 | | |
| F | EWS | 47000 | 479 | 0 | R | 315 330 | 2F 2U | 50 50 80 80 100 1L | | 00 | | |
| IF | EWL | 100000 | 10T | +20 | | 350 | 2V | 100 1L 105 1K 110 1M | Screw | Т5 | | |
| IF | EWB VSS VNS | 450000 | | 0 +30 | 0 | 360 | 2X 2Q | 120 1N 130 1P | Screw | т6 | | |
| F | VKS | 150000 | 15T | 0 +50 | 1 | 385 | 2Y | 140 1Q 150 1R | | D5 | | |
| IF | VRL | 220000 | 22T | +50 | | 400 420 | 2G 2M | 155 1E 160 1S | | 55 | | |
| F | VZS VRF | 330000 | 33Т | +15 | z | 420 | 2W | 165 1F 170 1T | | D6 | | |
| | | | | +5 +20 | D | 500 550 | 2H 25 | 180 1U 190 1V | | | | |
| | | 1000000 | 10M | +10 +50 | Y | 600 | 25 | 200 2L 215 2A | | | | |
| | | 1500000 | 15M | +50 | $\left \right $ | 630 | 2J | 040 014 | | | | |
| | | 2200000 | 22M | +30 | н | | | 210 2M 220 2N 240 2Q 250 2R 260 2S 270 2T | | | | |
| | | | | | | | | 260 2S | | | | |
| L | | 3300000 | 33M | | | | | | | | | |
| | | | | | | | | | | | | |

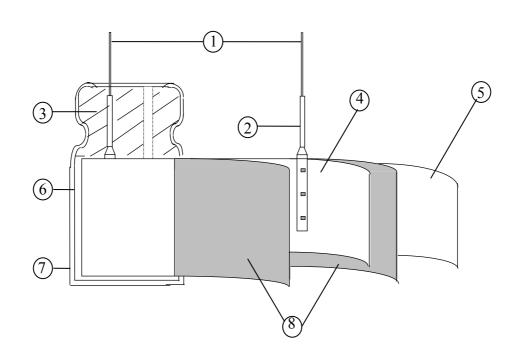
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3. Construction

Single ended type to be produced to fix the terminals to anode and cathode foil, and wind together with paper, and then wound element to be impregnated with electrolyte will be enclosed in an aluminum case. Finally sealed up tightly with end seal rubber, then finished by putting on the vinyl sleeve.



| No | Component | Material |
|----|------------------|--|
| 1 | Lead line | Tinned CP wire (Pb Free) |
| 2 | Terminal | Aluminum wire |
| 3 | Sealing Material | Rubber |
| 4 | Al-Foil (+) | Formed aluminum foil |
| 5 | Al-Foil (-) | Etched aluminum foil or formed aluminum foil |
| 6 | Case | Aluminum case |
| 7 | Sleeve | PVC/PET |
| 8 | Separator | Electrolyte paper |

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4. Characteristics

Standard atmospheric conditions

Unless otherwise specified, the standard range of atmospheric conditions for making measurements and tests are as follows:

| Ambient temperature | :15°C to 35°C |
|---------------------|-------------------|
| Relative humidity | : 45% to 85% |
| Air Pressure | : 86kPa to 106kPa |

If there is any doubt about the results, measurement shall be made within the following conditions:Ambient temperature: $20^{\circ}C \pm 2^{\circ}C$ Relative humidity: 60% to 70%Air Pressure: 86kPa to 106kPa

Operating temperature range

The ambient temperature range at which the capacitor can be operated continuously at rated voltage See table 1 temperature range.

As to the detailed information, please refer to table 2.

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| Tabl | | |
|------|---------------------------------------|--|
| | ITEM | PERFORMANCE |
| | Rated voltage (WV) | |
| 4.1 | | WV (V.DC) 200 220 250 400 420 450 |
| | Surge voltage (SV) | SV (V.DC) 250 270 300 450 470 500 |
| 4.2 | Nominal capacitance (Tolerance) | <condition>Measuring Frequency: 120Hz\pm12HzMeasuring Voltage: Not more than 0.5VrmsMeasuring Temperature: $20\pm 2^{\circ}C$<criteria>Shall be within the specified capacitance tolerance.</criteria></condition> |
| 4.3 | Leakage current | <condition></condition> Connecting the capacitor with a protective resistor $(1k \Omega \pm 10 \Omega)$ in series for 2 minutes, and then, measure Leakage Current. <criteria></criteria> Refer to Table 1 |
| 4.4 | tan δ | <condition> See 4.2, Norm Capacitance, for measuring frequency, voltage and temperature. <criteria> Refer to Table 1</criteria></condition> |

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| | | seconds. Bending Strength of Termina Fixed the capacitor, applied f | Force to the terminal is. Sorce to bent the termination of termination of the termination of te | n lead out direction for 10 ± 1 nal (1~4 mm from the rubber) ' to its original position within |
|-----|--------------------------------|--|---|---|
| | Terminal | Diameter of lead wire | Tensile force N | Bending force N |
| 4.5 | strength | Over 0.5mm to 0.8mm | (kgf) 10 (1.0) | (kgf) 5 (0.51) |
| | | < <u>Condition</u> > | | |
| | STEP Testing Tempe | | Time | |
| | | $1 20\pm 2$ | | reach thermal equilibrium |
| | | <u>2</u> -25 ± | | reach thermal equilibrium |
| | | $3 20\pm 2$ | | reach thermal equilibrium |
| | | | | reach thermal equilibrium |
| 4.6 | Temperature characteristics | <criteria></criteria> a. At +105 °C, capacitance r of its original value at +2 tan δ shall be within the l The leakage current mea value. b. In step 5, tan δ shall be w The leakage current shall | 0°C. imit of Item 4.4 sured shall not more rithin the limit of Item | than 8 times of its specified 4.4 |

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| | | | 200, 220 | 250 | 400 420 | 450 | 1 |
|-----|-------|--|-----------------|--------------------------------|------------------|---------------|------------------------------|
| | | Working Voltage (V) | 200~220 | 250 | 400~420 | 450 | |
| 4.6 | | Z-25 °C/Z+20 °C For capacitance value > | 3 1000 µ E A | $\frac{4}{14.05 \text{ part}}$ | 6 | 15 E for 7 |] 25°C/7±20°C |
| | | Capacitance, tan δ , and | A | dd 1.0 per | another 1000 a | ↓ F for Z- | 40°C/Z+20°C. |
| | | <condition></condition> | | .1 1 57 | | | |
| | | According to IEC60384 at a temperature of 105 | | | | | nula aumant fa |
| | | 2000 + 48/0 hours. (Th | | | 01 | | |
| | | working voltage) The | | | · · | | |
| | Load | atmospheric condition | | | | | C |
| .7 | life | <criteria></criteria> | | | | | |
| | test | The characteristic sha | | - | - | | |
| | | Leakage current | | | be satisfied | | |
| | | Capacitance Change | | | initial value. | · C 1 1 | |
| | | tan δ | | | 0% of the spec | | ie. |
| | | Appearance | There s | hall be no | leakage of elec | ctrolyte. | |
| | | <condition></condition> | | | | | |
| | | The capacitors are then s | stored with no | o voltage a | pplied at a tem | perature | of $105 \pm 2^{\circ}$ C for |
| | | 1000+48/0 hours. | | | | - | |
| | | Following this period the | | | | the test of | chamber and be |
| | | allowed to stabilized at r | - | | | | ith D.C. meter |
| | | Next they shall be conn voltage applied for 30m | | | • | | |
| | Shelf | tested the characteristics | | lien the ea | paenors shan | be disent | inged, and then |
| 4.8 | life | <criteria></criteria> | | | | | |
| | test | The characteristic shall r | | | | | _ |
| | | Leakage current | | 4.3 shall b | | | |
| | | Capacitance Change | | | nitial value. | | _ |
| | | tan δ | | | % of the specifi | | |
| | | Appearance | | | akage of elect | | |
| | | Remark: If the capacitor | rs are stored i | nore than 1 | l year, the leak | age curre | nt may increase |

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| | | <condition> Applied a surge voltage to the capacitor connected with a (100 ±50)/C_R (kΩ) resistor. The capacitor shall be submitted to 1000 cycles, each consisting of charge of 30 ±5s, followed discharge of 5 min 30s. The test temperature shall be 15~35°C. C_R :Nominal Capacitance (μ F)</condition> |
|------|-------------------|---|
| 4.9 | Surge test | Criteria>Leakage currentNot more than the specified value.Capacitance ChangeWithin $\pm 15\%$ of initial value. $\tan \delta$ Not more than the specified value.AppearanceThere shall be no leakage of electrolyte.Attention:This test simulates over voltage at abnormal situation only. It is not applicable to such over voltage as often applied. |
| 4.10 | Vibration test | Condition> The following conditions shall be applied for 2 hours in each 3 mutually perpendicular directions. Vibration frequency range : 10Hz ~ 55Hz Peak to peak amplitude : 1.5mm Sweep rate : 10Hz ~ 55Hz ~ 10Hz in about 1 minute Mounting method: The capacitor with diameter greater than 12.5mm or longer than 25mm must be fixed in place with a bracket. 4mm or less Within 30° 4mm or less To be soldered |

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| | | <criteria></criteria> | | | | | |
|-------|---------------------------|--|---|--|--|--|--|
| | | After the test, the follow | - | | | | |
| | | Inner construction | Inner construction No intermitte | | | | |
| | | | | nage of tab terminals or electrodes. | | | |
| | | A mm a a mm a a | | chanical damage in terminal. No leakage | | | |
| | | Appearance | | trolyte or swelling of the case. | | | |
| | | | The markings shall be legible. | | | | |
| | | | | | | | |
| | | <condition></condition> | 1 1 | | | | |
| | | The capacitor shall be test | | - | | | |
| | | Soldering temperature | | : 245±3°C : 2mm | | | |
| | | Dipping depth Dipping speed | | : 25±2.5mm/s | | | |
| | | Dipping time | | : 3±0.5s | | | |
| | | Dipping time | | . 5±0.58 | | | |
| 4 1 1 | Solderability | <criteria></criteria> | | | | | |
| 4.11 | | | | | | | |
| 4.11 | test | | | A minimum of 95% of the surface being | | | |
| 4.11 | test | Coating quality | | A minimum of 95% of the surface being immersed | | | |
| 4.11 | test | <condition></condition> | r shall be | e | | | |
| 4.11 | test | <condition> Terminals of the capacito</condition> | | immersed | | | |
| 4.11 | test | <condition> Terminals of the capacito</condition> | | immersed | | | |
| 4.11 | test | Condition> Terminals of the capacito $260 \pm 5^{\circ}$ for 10 ± 1 second the body of capacitor . | ds or 400 pe left un | immersed e immersed into solder bath at $0 \pm 10^{\circ}$ C for3 ⁺¹ ₋₀ seconds to 1.5~2.0mm from der the normal temperature and normal | | | |
| 4.11 | Resistance to | Condition> Terminals of the capacito $260 \pm 5^{\circ} C$ for 10 ± 1 second the body of capacitor. Then the capacitor shall be | ds or 400 pe left un | immersed e immersed into solder bath at $0 \pm 10^{\circ}$ C for3 ⁺¹ ₋₀ seconds to 1.5~2.0mm from der the normal temperature and normal | | | |
| 4.11 | Resistance to solder heat | <condition> Terminals of the capacito 260±5°C for10±1second the body of capacitor . Then the capacitor shall the humidity for 1~2 hours be <criteria> Leakage current</criteria></condition> | ds or 400 be left un efore me | immersed e immersed into solder bath at $0 \pm 10^{\circ}$ C for3 ⁺¹ ₋₀ seconds to 1.5~2.0mm from der the normal temperature and normal asurement. | | | |
| | Resistance to | <condition> Terminals of the capacito 260±5°C for10±1second the body of capacitor . Then the capacitor shall the humidity for 1~2 hours boots <criteria> Leakage current Capacitance Change</criteria></condition> | ds or 400 be left un efore me Not Wit | immersed immersed into solder bath at $0 \pm 10^{\circ}$ C for3 ⁺¹ ₋₀ seconds to 1.5~2.0mm from der the normal temperature and normal asurement. immersed | | | |
| | Resistance to solder heat | <condition> Terminals of the capacito 260±5°C for10±1second the body of capacitor . Then the capacitor shall the humidity for 1~2 hours be <criteria> Leakage current</criteria></condition> | ds or 400 be left un efore me Not Not | immersed e immersed into solder bath at $0 \pm 10^{\circ}$ C for3 ⁺¹ ₋₀ seconds to 1.5~2.0mm from der the normal temperature and normal asurement. | | | |

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| | | <condition> Temperature Cycle: According to IEC60384-4No.4.7methods, ca oven, the condition according as below:</condition> | · · |
|------|-----------------------|--|---|
| | | Temperature | Time |
| | | (1)+20°C | ≤ 3 Minutes |
| | | (2)Rated low temperature (-25°C) | 30 ± 2 Minutes |
| | | (3)Rated high temperature $(+105^{\circ}C)$ | 30 ± 2 Minutes |
| | | (1) to (3)=1 cycle, total 5 cycle | |
| 4.13 | Change of temperature | <criteria> The characteristic shall meet the following rea</criteria> | quirement |
| | test | Leakage current Not more than the | e specified value. |
| | | $\tan \delta$ Not more than the | - |
| | | Appearance There shall be no | leakage of electrolyte. |
| | | | |
| | | <condition> Humidity Test: According to IEC60384-4No.4.12 methods, ca be exposed for 500±8 hours in an atmospher</condition> | e of 90~95%R H .at |
| | | Humidity Test: According to IEC60384-4No.4.12 methods, ca | e of 90~95%R H .at |
| | | Humidity Test: According to IEC60384-4No.4.12 methods, ca be exposed for 500 ± 8 hours in an atmospher $40\pm 2^{\circ}$ C, the characteristic change shall meet Criteria > | e of 90~95%R H .at |
| | | Humidity Test:According to IEC60384-4No.4.12 methods, carbe exposed for 500 ± 8 hours in an atmospher $40 \pm 2^{\circ}$ C, the characteristic change shall meet <criteria></criteria> Leakage currentNot more than the sp | e of 90~95%R H .at the following requirement. |
| 4.14 | Damp | Humidity Test:According to IEC60384-4No.4.12 methods, carbe exposed for 500 ± 8 hours in an atmospher $40 \pm 2^{\circ}$ C, the characteristic change shall meetCriteria>Leakage currentNot more than the spCapacitance ChangeWithin $\pm 20\%$ of in | e of 90~95%R H .at the following requirement. pecified value. |
| 4.14 | heat | Humidity Test:According to IEC60384-4No.4.12 methods, carbe exposed for 500 ± 8 hours in an atmospher $40 \pm 2^{\circ}$ C, the characteristic change shall meet <criteria></criteria> Leakage currentNot more than the spCapacitance ChangeWithin $\pm 20\%$ of intan δ Not more than 120\% | e of 90~95%R H .at the following requirement. eccified value. itial value. o f the specified value. |
| 4.14 | 1 | Humidity Test:According to IEC60384-4No.4.12 methods, carbe exposed for 500 ± 8 hours in an atmospher $40 \pm 2^{\circ}$ C, the characteristic change shall meetCriteria>Leakage currentNot more than the spCapacitance ChangeWithin $\pm 20\%$ of in | e of 90~95%R H .at the following requirement. ecified value. itial value. o f the specified value. |

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| 4.15 | Vent test | <condition> The following test only apply to those products with vent products at diameter ≥Ø6.3 with vent. D.C. test The capacitor is connected with its polarity reversed to a DC power source. Then a current selected from below table is applied. <table 3=""> </table></condition> |
|------|--------------|--|
|------|--------------|--|

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5. It refers to the latest document of "Environment-related Substances standard" (WI-HSPM-QA-072).

| | Substances | | |
|-------------------|--|--|--|
| | Cadmium and cadmium compounds | | |
| Heavy metals | Lead and lead compounds | | |
| ficavy metals | Mercury and mercury compounds | | |
| | Hexavalent chromium compounds | | |
| | Polychlorinated biphenyls (PCB) | | |
| Chloinated | Polychlorinated naphthalenes (PCN) | | |
| organic | Polychlorinated terphenyls (PCT) | | |
| compounds | Short-chain chlorinated paraffins(SCCP) | | |
| | Other chlorinated organic compounds | | |
| D · (1 | Polybrominated biphenyls (PBB) | | |
| Brominated | Polybrominated diphenylethers(PBDE) (including | | |
| organic | decabromodiphenyl ether[DecaBDE]) | | |
| compounds | Other brominated organic compounds | | |
| Tributyltin comp | oounds(TBT) | | |
| Triphenyltin con | npounds(TPT) | | |
| Asbestos | | | |
| Specific azo con | npounds | | |
| Formaldehyde | | | |
| Beryllium oxide | | | |
| Beryllium copp | er | | |
| Specific phthalat | tes (DEHP,DBP,BBP,DINP,DIDP,DNOP,DNHP) | | |
| Hydrofluorocarb | on (HFC), Perfluorocarbon (PFC) | | |
| Perfluorooctane | sulfonates (PFOS) | | |
| Specific Benzotr | iazole | | |

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Attachment: Application Guidelines

1.Circuit Design

1.1 Operating Temperature and Frequency

Electrolytic capacitor electrical parameters are normally specified at 20° C temperature and 120Hz frequency. These parameters vary with changes in temperature and frequency. Circuit designers should take these changes into consideration.

- (1) Effects of operating temperature on electrical parameters
 - a) At higher temperatures, leakage current and capacitance increase while equivalent series resistance (ESR) decreases.
 - b) At lower temperatures, leakage current and capacitance decrease while equivalent series resistance (ESR) increases.
- (2) Effects of frequency on electrical parameters
 - a) At higher frequencies capacitance and impedance decrease while tan δ increases.
 - b) At lower frequencies, ripple current generated heat will rise due to an increase in equivalent series resistance (ESR).
- 1.2 Operating Temperature and Life Expectancy See the file: Life calculation of aluminum electrolytic capacitor
- 1.3 Common Application Conditions to Avoid The following misapplication load conditions will cause rapid deterioration to capacitor electrical parameters. In addition, rapid heating and gas generation within the capacitor can occur causing the pressure relief vent to operate and resultant leakage of electrolyte. Under Leaking electrolyte is combustible and electrically conductive.

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(1) Reverse Voltage

DC capacitors have polarity. Verify correct polarity before insertion. For circuits with changing or uncertain polarity, use DC bipolar capacitors. DC bipolar capacitors are not suitable for use in AC circuits.

(2) Charge / Discharge Applications

Standard capacitors are not suitable for use in repeating charge / discharge applications. For charge / discharge applications consult us and advise actual conditions.

(3) Over voltage

Do not apply voltages exceeding the maximum specified rated voltage. Voltages up to the surge voltage rating are acceptable for short periods of time. Ensure that the sum of the DC voltage and the superimposed AC ripple voltage does not exceed the rated voltage.

(4) Ripple Current

Do not apply ripple currents exceeding the maximum specified value. For high ripple current applications, use a capacitor designed for high ripple currents or contact us with your requirements. Ensure that allowable ripple currents superimposed on low DC bias voltages do not cause reverse voltage conditions.

- 1.4 Using Two or More Capacitors in Series or Parallel
- (1) Capacitors Connected in Parallel

The circuit resistance can closely approximate the series resistance of the capacitor causing an imbalance of ripple current loads within the capacitors. Careful design of wiring methods can minimize the possibility of excessive ripple currents applied to a capacitor.

- (2) Capacitors Connected in Series Normal DC leakage current differences among capacitors can cause voltage imbalances. The use of voltage divider shunt resistors with consideration to leakage current can prevent capacitor voltage imbalances.
- 1.5 Capacitor Mounting Considerations
- (1) Double Sided Circuit Boards

Avoid wiring pattern runs, which pass between the mounted capacitor and the circuit board. When dipping into a solder bath, excess solder may collect under the capacitor by capillary action and short circuit the anode and cathode terminals.

(2)Circuit Board Hole Positioning

The vinyl sleeve of the capacitor can be damaged if solder passes through a lead hole for subsequently processed parts. Special care when locating hole positions in proximity to capacitors is recommended.

(3)Circuit Board Hole Spacing

The circuit board holes spacing should match the capacitor lead wire spacing within the specified tolerances. Incorrect spacing can cause excessive lead wire stress during the insertion process. This may result in premature capacitor failure due to short or open circuit, increased leakage current, or electrolyte leakage.

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| (4) Clearance for Case Mounted Pressure Relief vents Capacitors with case mounted pressure relief vents require sufficient clearance to allow for proper vent operation. The minimum clearances are dependent on capacitor diameters as proper vent operation. The minimum clearances are dependent on capacitor diameters as follows. Φ 6.3~ Φ 16mm:2mm minimum, Φ 18~ Φ 35mm:3mm minimum, Φ 40mm or greater:5mm minimum. |
|--|
| (5) Clearance for Seal Mounted Pressure Relief VentsA hole in the circuit board directly under the seal vent location is required to allow proper release of pressure. |
| (6) Wiring Near the Pressure Relief Vent Avoid locating high voltage or high current wiring or circuit board paths above the pressure relief vent. Flammable, high temperature gas exceeding 100°C may be released which could dissolve the wire insulation and ignite. |
| (7) Circuit Board patterns Under the Capacitor Avoid circuit board runs under the capacitor as electrolyte leakage could cause an electrical short. |
| (8) Screw Terminal Capacitor Mounting Do not orient the capacitor with the screw terminal side of the capacitor facing downwards. Tighten the terminal and mounting bracket screws within the torque range specified in the specification. |
| 1.6 Electrical Isolation of the Capacitor Completely isolate the capacitor as follows. (1) Between the cathode and the case (except for axially leaded B types) and between the anode terminal and other circuit paths |
| (2) Between the extra mounting terminals (on T types) and the anode terminal, cathode terminal, and other circuit paths. |
| 1.7 The Product endurance should take the sample as the standard. 1.8 If conduct the load or shelf life test, must be collect date code within 6 months products of sampling. 1.9 Capacitor Sleeve |
| The vinyl sleeve or laminate coating is intended for marking and identification purposes and is not meant to electrically insulate the capacitor. The sleeve may split or crack if immersed into solvents such as toluene or xylene, and then exposed to high temperatures. |
| CAUTION! Always consider safety when designing equipment and circuits. Plan for worst case failure modes such as short circuits and open circuits which could occur during use. (1) Provide protection circuits and protection devices to allow safe failure modes. (2) Design redundant or secondary circuits where possible to assure continued operation in case of main circuit failure. |
| |

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2. Capacitor Handling Techniques

- 2.1 Considerations Before Using
- (1) Capacitors have a finite life. Do not reuse or recycle capacitors from used equipment.
- (2) Transient recovery voltage may be generated in the capacitor due to dielectric absorption. If required, this voltage can be discharged with a resistor with a value of about $1k \Omega$.
- (3) Capacitors stored for long periods of time may exhibit an increase in leakage current. This can be corrected by gradually applying rated voltage in series with a resistor of approximately $1k \Omega$.
- (4) If capacitors are dropped, they can be damaged mechanically or electrically. Avoid using dropped capacitors.
- (5) Dented or crushed capacitors should not be used. The seal integrity can be compromised and loss of electrolyte / shortened life can result.
- 2.2 Capacitor Insertion
- * (1) Verify the correct capacitance and rated voltage of the capacitor.
- * (2) Verify the correct polarity of the capacitor before inserting.
- * (3) Verify the correct hole spacing before insertion (land pattern size on chip type) to avoid stress on the terminals.
 (4) Ensure that the auto insertion equipment lead clinching operation does not stress the capacitor leads where they enter the seal of the capacitor.

For chip type capacitors, excessive mounting pressure can cause high leakage current, short circuit, or disconnection.

2.3 Manual Soldering

- (1) Observe temperature and time soldering specifications or do not exceed temperatures of 400 $^\circ$ C for 3 seconds or less.
- (2) If lead wires must be formed to meet terminal board hole spacing, avoid stress on the lead wire where it enters the capacitor seal.
- (3) If a soldered capacitor must be removed and reinserted, avoid excessive stress to the capacitor leads.
- (4) Avoid touching the tip of the soldering iron to the capacitor, to prevent melting of the vinyl sleeve.

2.4 Flow Soldering

- (1) Do not immerse the capacitor body into the solder bath as excessive internal pressure could result.
- (2) Observe proper soldering conditions (temperature, time, etc.) Do not exceed the specified limits.
- (3) Do not allow other parts or components to touch the capacitor during soldering.

2.5 Other Soldering Considerations

Rapid temperature rises during the preheat operation and resin bonding operation can cause cracking of the capacitor vinyl sleeve.

For heat curing, do not exceed 150°C for a maximum time of 2 minutes.

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2.6 Capacitor Handling after Solder

- (1). Avoid movement of the capacitor after soldering to prevent excessive stress on the lead wires where they enter the seal.
- (2). Do not use capacitor as a handle when moving the circuit board assembly.
- (3). Avoid striking the capacitor after assembly to prevent failure due to excessive shock.

2.7 Circuit Board Cleaning

- * (1) Circuit boards can be immersed or ultrasonically cleaned using suitable cleaning solvents for up 5 minutes and up to 60°C maximum temperatures. The boards should be thoroughly rinsed and dried.
- The use of ozone depleting cleaning agents is not recommended in the interest of protecting the environment.
- * (2) Avoid using the following solvent groups unless specifically allowed for in the specification;
- Halogenated cleaning solvents: except for solvent resistant capacitor types, halogenated solvents can permeate the seal and cause internal capacitor corrosion and failure. For solvent resistant capacitors, carefully follow the temperature and time requirements of the specification. 1-1-1 trichloroethane should never be used on any aluminum electrolytic capacitor.
- . Alkali solvents : could attack and dissolve the aluminum case.
- . Petroleum based solvents: deterioration of the rubber seal could result.
- . Xylene : deterioration of the rubber seal could result.
- Acetone : removal of the ink markings on the vinyl sleeve could result.
- * (3) A thorough drying after cleaning is required to remove residual cleaning solvents which may be trapped between the capacitor and the circuit board. Avoid drying temperatures, which exceed the maximum rated temperature of the capacitor.
- * (4) Monitor the contamination levels of the cleaning solvents during use by electrical conductivity, pH, specific gravity, or water content. Chlorine levels can rise with contamination and adversely affect the performance of the capacitor.

Please consult us for additional information about acceptable cleaning solvents or cleaning methods.

2.8 Mounting Adhesives and Coating Agents

When using mounting adhesives or coating agents to control humidity, avoid using materials containing halogenated solvents. Also, avoid the use of chloroprene based polymers.

After applying adhesives or coatings, dry thoroughly to prevent residual solvents from being trapped between the capacitor and the circuit board.

3. Precautions for using capacitors

3.1 Environmental Conditions

- Capacitors should not be stored or used in the following environments.
- * (1) Temperature exposure above the maximum rated or below the minimum rated temperature of the capacitor.
- * (2) Direct contact with water, salt water, or oil.
- * (3) High humidity conditions where water could condense on the capacitor.

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- * (4) Exposure to toxic gases such as hydrogen sulfide, sulfuric acid, nitric acid chlorine, or ammonia.
- * (5) Exposure to ozone, radiation, or ultraviolet rays.
- * (6) Vibration and shock conditions exceeding specified requirements.

3.2 Electrical Precautions

- (1) Avoid touching the terminals of the capacitor as possible electric shock could result. The exposed aluminum case is not insulated and could also cause electric shock if touched.
- (2) Avoid short circuit the area between the capacitor terminals with conductive materials including liquids such as acids or alkaline solutions.

4. Emergency Procedures

- (1) If the pressure relief vent of the capacitor operates, immediately turn off the equipment and disconnect form the power source. This will minimize additional damage caused by the vaporizing electrolyte.
- (2) Avoid contact with the escaping electrolyte gas which can exceed 100°C temperatures.
 If electrolyte or gas enters the eye, immediately flush the eyes with large amounts of water.
 If electrolyte or gas is ingested by month, gargle with water.
 If electrolyte contacts the skin, wash with soap and water.

5. Long Term Storage

Leakage current of a capacitor increases with long storage times. The aluminum oxide film deteriorates as a function of temperature and time. If used without reconditioning, an abnormally high current will be required to restore the oxide film. This current surge could cause the circuit or the capacitor to fail.

After one year, a capacitor should be reconditioned by applying rated voltage in series with a 1000Ω , current limiting resistor for a time period of 30 minutes .

If the expired date of products date code is over eighteen months, the products should be return to confirmation. 5.1 Environmental Conditions

The capacitor shall be not use in the following condition:

- (1) Temperature exposure above the maximum rated or below the minimum rated temperature of the capacitor.
- (2) Direct contact with water, salt water, or oil.
- (3) High humidity conditions where water could condense on the capacitor.
- (4) Exposure to toxic gases such as hydrogen sulfide, sulfuric acid, nitric acid, chlorine, or ammonia.
- (5) Exposure to ozone, radiation, or ultraviolet rays.
- (6) Vibration and shock conditions exceeding specified requirements.

6. Capacitor Disposal

When disposing of capacitors, use one of the following methods.

* Incinerate after crushing the capacitor or puncturing the can wall (to prevent explosion due to internal pressure rise). Capacitors should be incinerated at high temperatures to prevent the release of toxic gases such as chlorine from the polyvinyl chloride sleeve, etc.

Dispose of as solid waste.
 NOTE: Local laws may have specific disposal requirements, which must be followed.

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